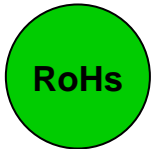


SPECIFICATION FOR APPROVAL



CUSTOMER

CUSTOMER'S DWG NO.

REVISION NO.

CUSTOMER'S PART NO.

TECSTAR'S PART NO.

TL160808-5R6K

QUANTITY

PCS

ITEM

DATE

SEP/03/2009

	“√”	CUSTOMER'S SIGNATURE	NOTE
FULL APPROVED			
CONDITONAL APPROVED			
REJECTED			



TECSTAR TECHNOLOGY CO., LTD.

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TEL : 886-3-4788701

FAX : 886-3-4788702

www tecstar.com.tw

SPECIFICATION FOR APPROVAL

CUSTOMER:		CUSTOMER'S P/N:			
VENDOR'S P/N:		TL160808-5R6K			
<p>DIMENSION:(m/m)</p>		A	1.6 ± 0.2	m/m	
		B	0.8 ± 0.2	m/m	
		C	0.8 ± 0.2	m/m	
		D	0.3 ± 0.2	m/m	
		E		m/m	
		F		m/m	
		G		m/m	
		H		m/m	
		I		m/m	
		J		m/m	
		K		m/m	
		L		m/m	
		M		m/m	
		N		m/m	
O		m/m			
ELECTRICAL REQUIREMENTS		TEST INSTRUMENTS			
L	5.6 ± 10% μH	TEST FREQ.	<input checked="" type="radio"/> HP 4338A MILLIOHMMETER <input type="radio"/> HP 4195A NETWORK/SPECTRUM ANALYZER <input type="radio"/> HP 4284A BIAS CURRENT SOURCE <input type="radio"/> HP 4285A PRECISION LCR METER <input type="radio"/> HP 4286A PRECISION LCR METER <input checked="" type="radio"/> HP 4291B RF IMPEDANCE /MATERIAL ANALYZER <input type="radio"/> HP 6632A DC POWER SUPPLY		
Q	35 MIN.	TEST FREQ.			4MHz/100mV
Srf	22 MHz MIN.	TEST FREQ.			MHz
Rdc	1.55 OHM. MAX.	TEST FREQ.			MHz
Idc	5 mA MAX.	TEST FREQ.			MHz
DRAWN BY		CHECKED BY		APPROVED BY	
Juli Wang		John Chuang		Lionel Lin	

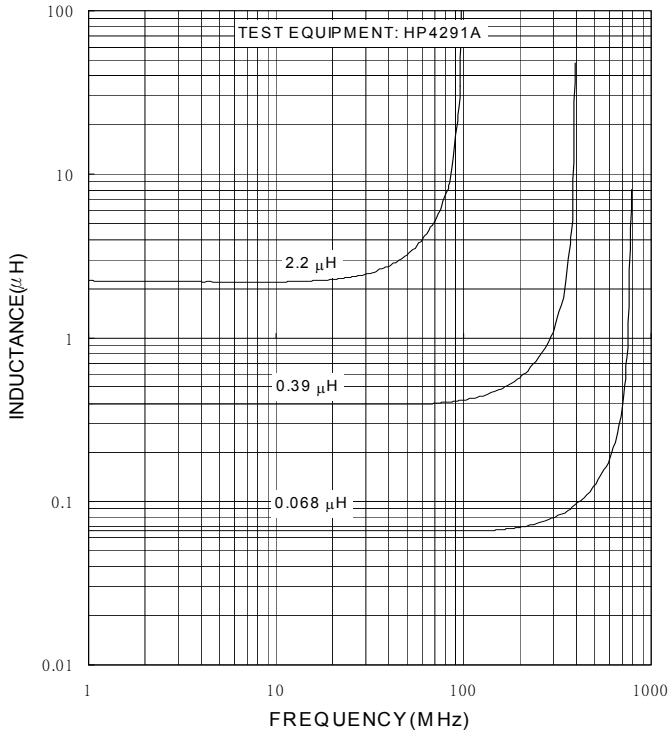
TEST DATA

CUSTOMER:							
CUSTOMER'S P/N:						SERIES NO:	TL3021
VENDOR'S P/N:		TL160808-5R6K				DATE:	03-SEP-2009
MEAS	A	B	C	D	L	Q	Rdc
ITEM	(m/m)	(m/m)	(m/m)	(m/m)	(μ H)		(Ω)
SPEC	1.6 ± 0.2	0.8 ± 0.2	0.8 ± 0.2	0.3 ± 0.2	$5.6 \pm 10\%$	35 MIN.	1.55 MAX.
TEST FREQ.					4MHz	4MHz	
1	1.02	0.82	0.80	0.30	5.40	56.2	1.057
2	1.00	0.84	0.82	0.33	5.58	57.7	1.096
3	1.04	0.81	0.84	0.29	5.66	59.8	1.100
4	1.01	0.81	0.81	0.32	5.41	58.7	1.064
5	1.03	0.82	0.82	0.30	5.71	60.2	1.028
6	1.02	0.83	0.80	0.33	5.39	59.3	1.099
7	1.00	0.81	0.83	0.28	5.49	57.4	1.028
8	1.02	0.82	0.81	0.32	5.77	56.5	1.043
9	1.01	0.81	0.82	0.30	5.47	59.2	1.073
10	1.03	0.84	0.81	0.33	5.71	57.1	1.080
AVG.	1.02	0.82	0.82	0.31	5.56	58.2	1.067
R	0.04	0.03	0.03	0.05	0.38	4.0	0.072
DRAWN BY			CHECKED BY			APPROVED BY	
Juli Wang			John Chuang			Lionel Lin	

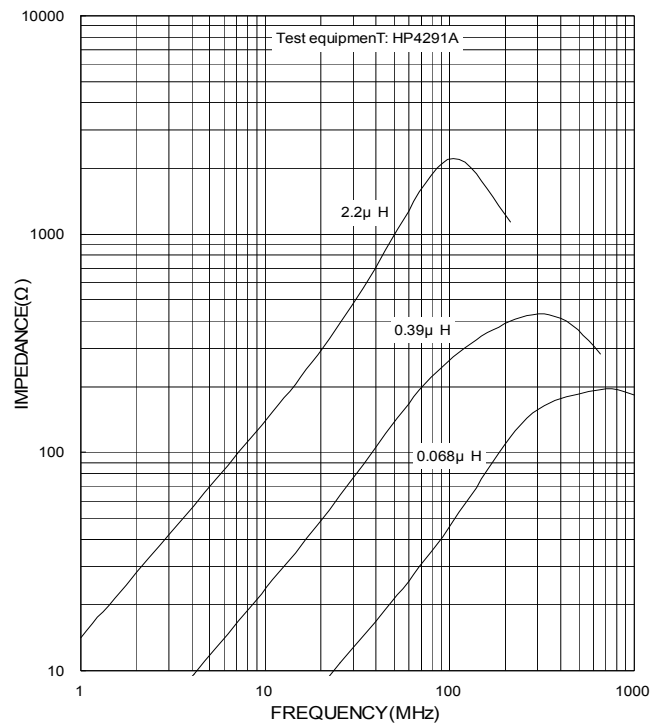
TYPICAL ELECTRICAL CHARACTERISTICS CURVE

TL160808 Type

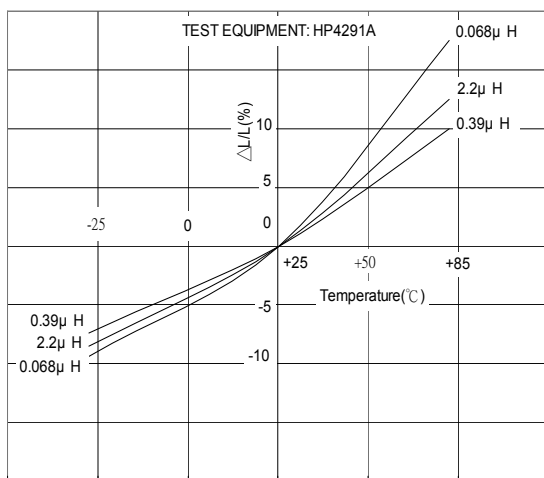
Inductance VS. Frequency



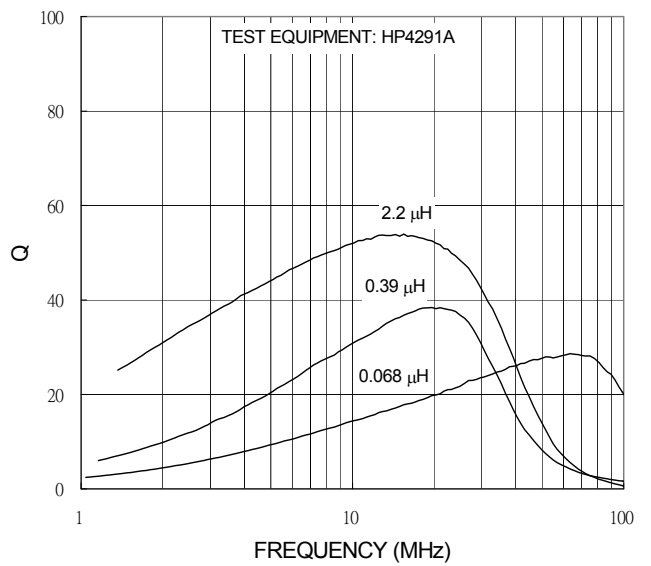
Impedance VS. Frequency



Inductance VS. Temperature

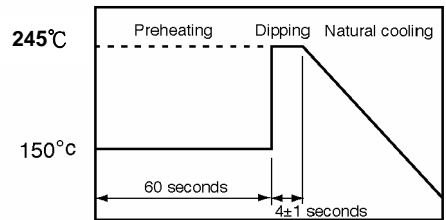
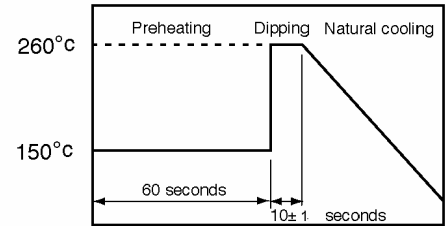


Q VS. Frequency



RELIABILITY TEST

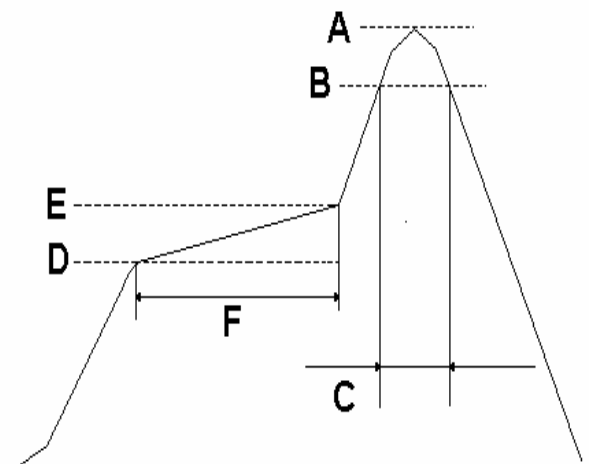
Item	Performance	Test condition
Operating temperature range	-55 °C to + 125 °C	
Storage temperature and umidity ranges	40 °C MAX., 70% RH MAX.	
Soldering heat resistance	The chip shall not be cracks. More than 75% of terminal electrode shall be covered with solder.	Preheat: 150 °C, 60 seconds Solder temperature : 260 ± 5 °C Flux: Rosin Dip time: 10 ± 1 seconds
Solderability	More than 90% of the terminal electrode shall be covered with new solder.	Preheat: 150 °C, 60 seconds Solder temperature: 245 ± 5 °C Flux: Rosin Dip time: 4 ± 1 seconds



Recommended Soldering Conditions

(REFLOW TEMPERATURE PROFILE) Lead-Free

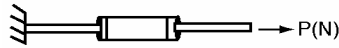
A	$260 \pm 5^{\circ}\text{C}$
B	$230 \pm 5^{\circ}\text{C}$
C	$30 \pm 10 \text{ sec}$
D	150°C
E	180°C
F	$90 \pm 30 \text{ sec}$



RELIABILITY TEST

Terminal strength

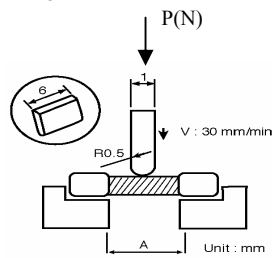
The terminal electrode and the body shall not be damaged by the forces applied on the right conditions.



Type	P (kgf)	Time (s)
T□100505	0.3	
T□160808	0.5	
T□201209	0.6	
T□201212	0.8	
T□321611	1.0	
T□322513	1.0	30 ± 5
T□451616	1.0	
T□453215	1.5	
TA3216M4	0.5	

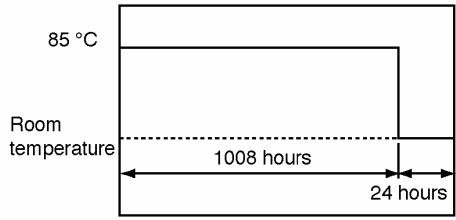
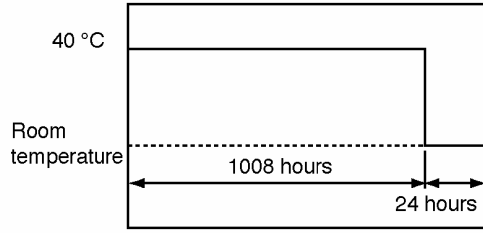
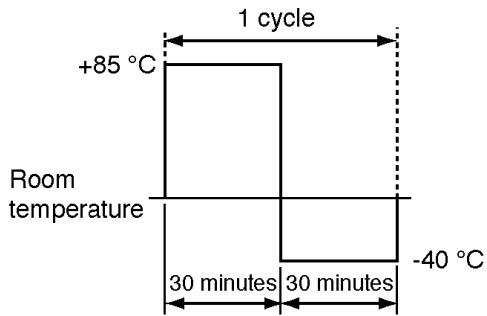
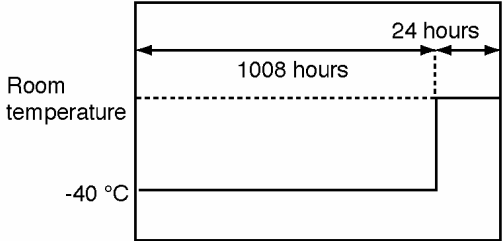
Bending strength

The body shall not be damaged by the forces applied on the right conditions.



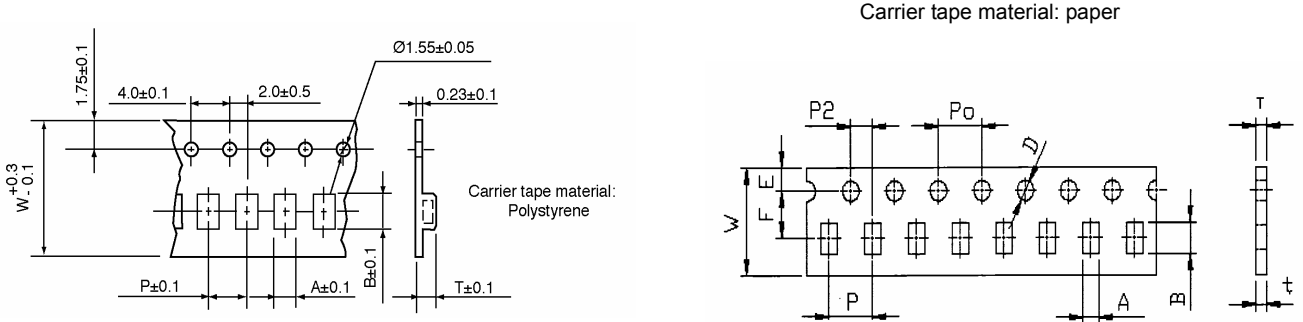
Type	A (mm)	P (kgf)
T□160808	1.0	0.5
T□201209	1.4	1.0
T□201212	1.4	1.2
T□321611	2.0	2.0
T□322513	2.0	2.5
T□451616	2.5	2.5
T□453215	2.7	2.5
TA3216M4	1.4	1.0

RELIABILITY TEST

Item	Performance	Test condition
High temperature resistance	Appearance : Ferrite shall not be damaged. Inductance : Within±10% of the initial value. Q: Within±30% of the initial value.	Temperature: 85±2°C Testing time: 1008±12 hours Measurement: After placing for 24 hours min 
Humidity resistance	Appearance: Ferrite shall not be damaged. Inductance: Within±10% of the initial value Q: Within±30 % of the initial value.	Humidity: 90 to 95% RH Temperature: 40±2°C Testing time: 1008±12 hours Measurement: After placing for 24 hours min 
Thermal Shock	Appearance: Cracking, chipping or any other defects harmful to the characteristics shall not be allowed. Inductance: Within±10% of the initial value Q: Within±30% of the initial value.	Temperature: -40°C, +85°C, kept stabilized for 30 minutes each Cycle: 100 cycles Measurement: After placing for 24 hours min 
Low temperature storage life test	Appearance: Cracking, chipping or any other defects harmful to the characteristics shall not be allowed. Inductance: Within±10% of the initial value. Q: Within±30% of the initial value.	Temperature: -40±2°C Testing time: 1008±12 hours Measurement: After placing for 24 hours min 

PACKAGING

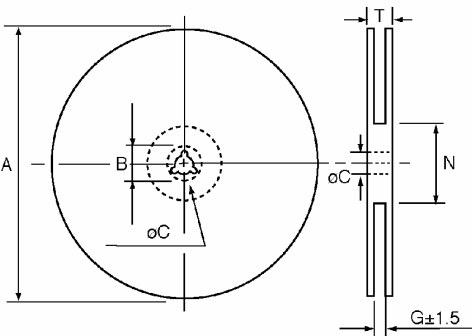
- Tape dimensions and packaging quantities



material: Paper (Dimensions in mm)						
TYPE	A	B	W	P	T	CHIPS / REEL
100505	0.62	1.12	8	2	0.60	10000
160808	1.10	1.90	8	4	0.95	4000
201209	1.50	2.30	8	4	0.95	4000
material: Polystyrene (Dimensions in mm)						
TYPE	A	B	W	P	T	CHIPS / REEL
160808	1.01	1.80	8	4	1.02	4000
201209	1.42	2.25	8	4	1.04	4000
201212	1.50	2.35	8	4	1.45	2000
321611	1.88	3.50	8	4	1.27	3000

- Reel dimensions

Material: Paper, Plastic



Dimensions in mm

TYPE	8mm	12mm
A	178±2	178±2
B	21.0±0.8	21.0±0.8
C	13.0±0.8	13.0±0.8
G	10.0	14.0
N	75	75
T	12.5	16.5

